



ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

Halogen Free & RoHs Compliance

SPECIFICATION FOR APPROVAL

CUSTOMER :

CUSTOMER P/N :

OUR DWG No :

QUANTITY : 0 Pcs. DATE : 2014/06/09

ITEM : MHCD252010A-R33M-A8L

SPECIFICATION ACCEPTED BY:

COMPONENT
ENGINEER

ELECTRICAL
ENGINEER

MECHANICAL
ENGINEER

APPROVED

REJECTED

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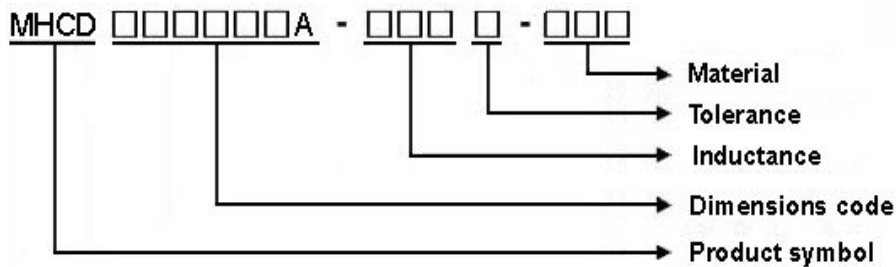


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MHCD252010A Series Specification

1 Scope: This specification applies to Alloy Molding power inductors

2 Part Numbering: Product Identification



3 Rating:

Operating Temperature: $-40^{\circ}\text{C} \sim 125^{\circ}\text{C}$ (Including self - temperature rise)

Storage Temperature: $-40^{\circ}\text{C} \sim 125^{\circ}\text{C}$ (after PCB)

$-5^{\circ}\text{C} \sim 35^{\circ}\text{C}$, Humidity 45% ~ 85% (before PCB)

4 Marking:

No Marking

5 Standard Testing Condition

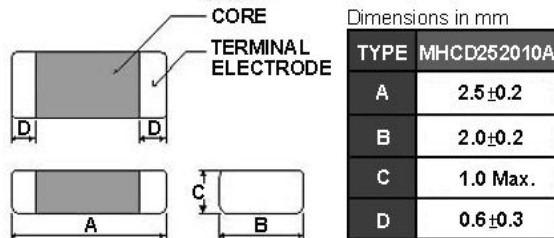
	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35℃)	20±2℃
Humidity	Ordinary Humidity(25 to 85% RH)	60 to 70 % RH



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6 Configuration and Dimensions:



7 ELECTRICAL CHARACTERISTICS :

Part No.	Inductance (uH)	Test Freq.	Irms(A) Max.(Typ)	Isat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)	Tolerance (±%)
MHCD252010A-R33M-A8L	0.33	2MHz,0.2V	4.0(4.5)	5.3(6.2)	25(22)	20

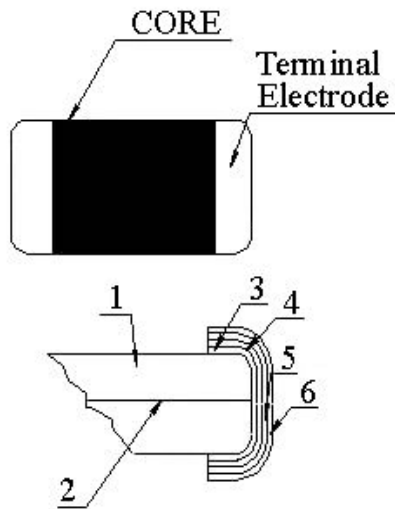
NOTE:

1. Operating temperature range — 4 0 °C ~ 1 2 5 °C(Including self - temperature rise)
2. Irms DC current (A) that will cause an approximate ΔT of 40°C.
3. Isat DC current (A) that will cause Lo to drop approximately 30%
4. All test data is referenced to 25°C ambient

MHCD252010A Series Specification

8 MHCD252010A Series

8.1 Construction:



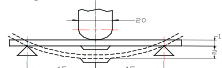
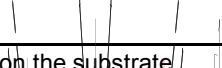
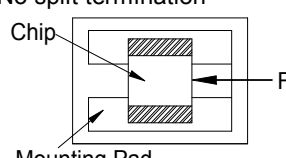
8.2 Material List:

NO	Part	Description
1	Core	Metal Power
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn

MHCD252010A Series Specification

9 Reliability Of Molding power inductors

1-1.Mechanical Performance

	Item	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right conditions must not damage the terminal electrode and the ferrite	Test device shall be soldered on the substrate Substrate Dimension: 100x40x1.6mm Deflection: 2.0mm Keeping Time: 30sec 
1-1-2	Vibration		Test device shall be soldered on the substrate Oscillation Frequency: 10 to 55 to 10Hz for 1min Amplitude: 1.5mm Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat	Appearance: No damage More than 75% of the terminal electrode should be covered with solder. Inductance: within $\pm 20\%$ of initial value	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 260 ± 5 °C Immersion Time: 10 ± 1 sec 
1-1-4	Solder ability	The electrodes shall be at least 95% covered with new solder coating	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 245 ± 5 °C Immersion Time: 4 ± 1 sec 
1-1-5	Terminal Strength Test	No split termination 	Test device shall be soldered on the substrate, then apply a force in the direction of the arrow. Force : 5N Keeping Time: 10 ± 1 sec 

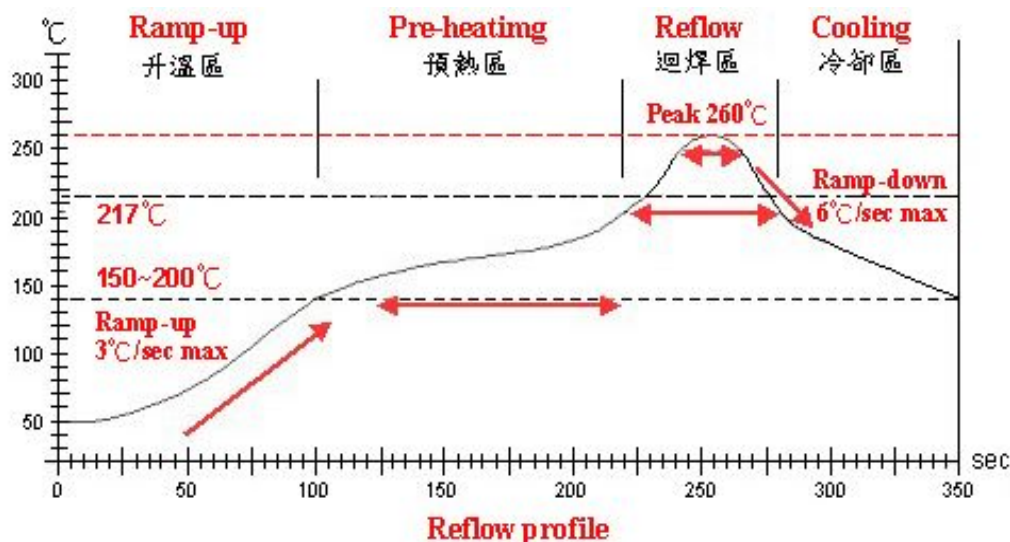
1-2.Environmental Performance

No	Item	Specification	Test Method		
1-2-1	Temperature Cycle	Appearance: No damage Inductance: within±20% of initial value	One cycle:		
			Step	Temperature (°C)	Time (min)
			1	-40±3	30
			2	25±2	2
			3	125±3	30
4	25±2	2			
			Total: 100cycles		
			Measured after exposure in the room condition for 24hrs		
1-2-2	Humidity Resistance		Temperature: 60±2℃ Relative Humidity: 90 ~ 95% / Time: 500hrs Measured after exposure in the room condition for 12hrs		
1-2-3	High Temperature Resistance		Temperature: 85±3℃ Relative Humidity: 0% / Time: 500hrs Measured after exposure in the room condition for 12hrs		
1-2-4	Low Temperature Resistance		Temperature: -40±3℃ Relative Humidity: 0% / Time: 500hrs Measured after exposure in the room condition for 12hrs		



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Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升温區 Ramp-up	預熱區 Pre-heating	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp. scope	R.T. ~ 150°C	150°C ~ 200°C	217°C	260±5°C	Peak Temp. ~ 150°C
標準時間 Time spec.	—	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	—
實際時間 Time result	—	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	—

NOTE :

1. Re-flow possible times : within 2 times
2. Nitrogen adopted is recommended while in re-flow



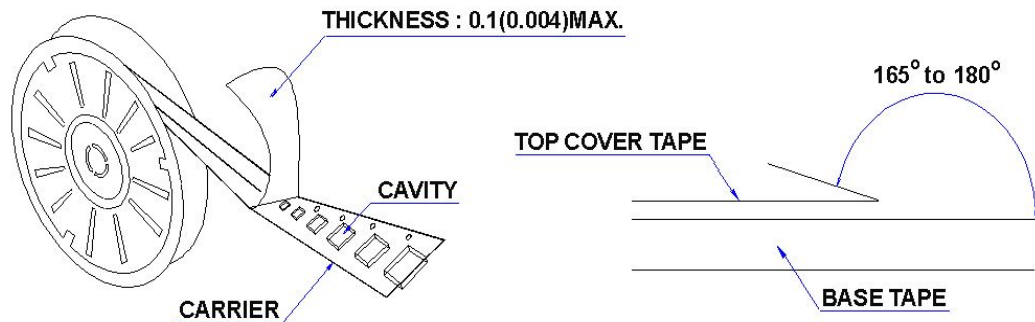
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MHCD252010A Series Specification

PACKAGING

11.1 Packaging -Cover tape

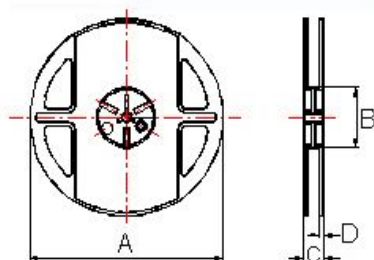
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



11.2 Packaging Quantity

TYPE	BULK	PCS/REEL
MHCD252010A	✓	3000

11.3 Reel Dimensions



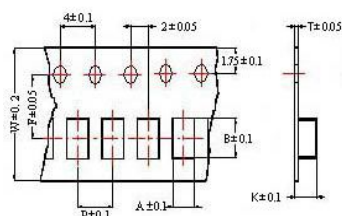
Dimensions in mm

TYPE	A	B	C	D
MHCD252010A	178	60	12	1.5

MHCD252010A Series Specification

PACKAGING

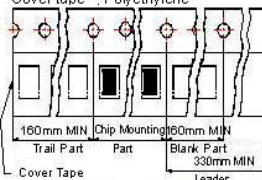
11.4 Tape Dimensions in mm



Tape Material

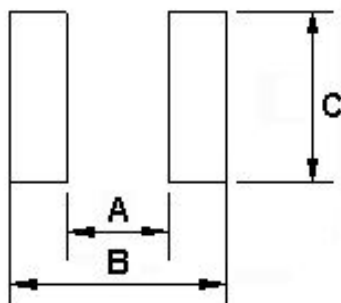
Carrier tape : Polycarbonate

Cover tape : Polyethylene



TYPE	A	B	T	W	P	F	K
MHCD252010A	2.25	2.80	0.22	8	4	3.5	1.35

Recommended Pattern



Dimensions in mm

TYPE	A	B	C
MHCD252010A	1.2	2.8	2.0

Note:

1. Please make sure that your product is has been evaluated and confirmed against your specifications when our product is mounted to your product.
2. Do not knock nor drop.
3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose, under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)

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